Specifications			FX3S-10M_	FX3S- 14M_	FX3S- 20M_	FX3S- 30M_	FX3S-30M 2AD
I/O points			Max. 30			1	
Address range			X0-X17/Y0-Y15 (octal)				
Power supply			100–240 V AC, 50/60 Hz or 24 V DC				
Program memory			16,000 steps EEPROM (internal), exchangeable EEPROM memory cassette; program capacity is limited to 4,000 steps				
Instruction Time			0.21 µs/basic instruction				
Integrated inputs	Number of inputs		6	8	12	16	
	Input signal voltage		24 V DC (±10 %)				
	Input form		sink/source				
	Response time		Approx. 10 ms				
	Isolation		Photocoupler isolation				
Integrated outputs	Number of outputs		4	6	8	14	
	Switching voltage		<240 V AC, <30 V DC (relay output), 5–30 V DC (transistor output)				
	Output type/form		Relay or transistor				
	Max. load	resistive	2 A/point, max. 8 A for 4 output points/common terminal (relay), 0.5 A/point; max. 0.8 A for 4 output points/common terminal (transistor)				
		inductive	80 VA (relay), 12 W/point (at 24 V DC); max. 19.2 W for 4 output points/common terminal (transistor)				
	Response time		10 ms (relay), <5 µs (for Y000 and Y001)/ 0.2 ms (for all other outputs) (transistor)				
	Isolation		Photocoupler isolation				
High-speed counters			21 total, with 16 1-phase (C235–C250) and 5 2-phase (C251–C255)				
Counting range			-2,147,483,648–2,147,483,647				
Service power supply			24 V DC, 400 mA				
Environment			0–55 °C ambient temperature; 5–95 % relative humidity				